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Dated: July 29, 2003

Signature: _____

(Marcus J. Millet)

Docket No.: TESSERA 3.0-139 DIV
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Thomas H. DiStefano

Application No.: 09/854,269

Group Art Unit: 2822

Filed: May 11, 2001

Examiner: M. Lewis

For: MICROELECTRONIC PACKAGES WITH
ELONGATED SOLDER INTERCONNECTIONS

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

REQUEST FOR CONSIDERATION OF INFORMATION
UNDER 37 C.F.R. § 1.97(D)

Dear Sir:

It is respectfully requested that the accompanying Supplemental Information Disclosure Statement, filed after issuance of a final rejection, be considered pursuant to 37 C.F.R. § 1.97(d). Please charge deposit account No. 12-1095 in the amount of \$180.00 pursuant to 37 C.F.R. § 1.17(p). In the event that any additional fee is due in connection with the present petition, the same should be charged to our Deposit Account No. 12-1095.

Dated: July 29, 2003

Respectfully submitted,

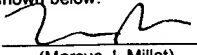
By _____
Marcus J. Millet
Registration No.: 28,241
LERNER, DAVID, LITTENBERG,
KRUMHOLZ & MENTLIK, LLP
600 South Avenue West
Westfield, New Jersey 07090
(908) 654-5000
Attorney for Applicant

08/01/2003 BSAYASI1 00000077 09854269

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SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

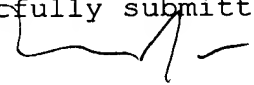
Dear Sir:

It is respectfully requested that the references listed on the enclosed form be made of record and considered with respect to the above-referenced U.S. patent application. A copy of each reference is enclosed. Submission of the present Supplemental Information Disclosure Statement should not be taken as an admission that the cited references are legally available prior art or that the same are pertinent or material.

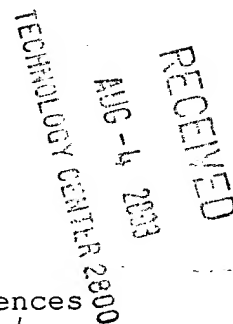
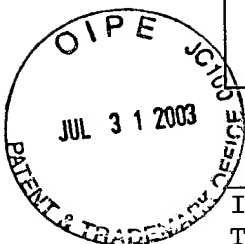
In the event that any fee is due in connection with the present Supplemental Information Disclosure Statement, the Commissioner is hereby authorized to charge the same to our Deposit Account No. 12-1095.

Dated: July 29, 2003

Respectfully submitted,

By 

Marcus J. Millet
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PTO/SB/08a/b (05-03)

Approved for use through 05/31/2003. OMB 0651-0031

U.S. Patent and Trademark Office; U.S. DEPARTMENT OF COMMERCE

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Substitute for form 1449/PTO INFORMATION DISCLOSURE STATEMENT BY APPLICANT (use as many sheets as necessary)				Complete if Known	
				Application Number	09/854,269
				Filing Date	May 11, 2001
				First Named Inventor	Thomas H. DiStefano
				Art Unit	2822
				Examiner Name	M. Lewis
Sheet	1	of	1	Attorney Docket Number	TESSERA 3.0-139 DIV

U.S. PATENT DOCUMENTS					
Examiner Initials*	Cite No. ¹	Document Number	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		Number-Kind Code ² (if known)			
	AA	US-3,509,270	04-28-1970	DUBE ET AL.	
	AB	US-3,616,532	11-02-1971	BECK	
	AC	US-4,245,273	01-13-1981	FEINBERG ET AL.	
	AD	US-4,642,889	02-17-1987	GRABBE	
	AE	US-4,664,309	05-12-1987	ALLEN ET AL.	
	AF	US-4,705,205	11-10-1987	ALLEN ET AL.	
	AG	US-6,215,196-B1	04-10-2001	ELDRIDGE ET AL.	
	AH	US-6,369,451-B2	04-09-2002	LIN	

FOREIGN PATENT DOCUMENTS					
Examiner Initials*	Cite No. ¹	Foreign Patent Document	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		Country Code ³ -Number ⁴ -Kind Code ⁵ (if known)			

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant. ¹ Applicant's unique citation designation number (optional). ² See Kinds Codes of USPTO Patent Documents at www.uspto.gov or MPEP 901.04. ³ Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ⁴ For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the application number of the patent document. ⁵ Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶ Applicant is to place a check mark here if English language Translation is attached.

NON PATENT LITERATURE DOCUMENTS			
Examiner Initials*	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ²

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹ Applicant's unique citation designation number (optional). ² Applicant is to place a check mark here if English language Translation is attached.

Examiner Signature		Date Considered	
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